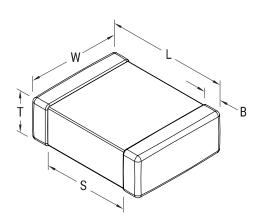
## KEMET Part Number: C0805C223K1RECTU

(C0805C223K1REC7800)



ESD SMD Comm X7R, Ceramic, 0.022 uF, 10%, 100 VDC, X7R, SMD, MLCC, Temperature Stable, Electro Static Discharge, Class II, 0805



Dimensions		
Chip Size	0805	
L	2mm +/-0.2mm	
W	1.25mm +/-0.2mm	
Т	0.78mm +/-0.10mm	
S	0.75mm MIN	
В	0.5mm +/-0.25mm	

Packaging Specifications		
Packaging:	T&R, 180mm, Paper Tape	
Packaging Quantity:	4000	

General Information		
Series:	ESD SMD Comm X7R	
Style:	SMD Chip	
Description:	SMD, MLCC, Temperature Stable, Electro Static Discharge, Class II	
Features:	Temperature Stable, Class II	
RoHS:	Yes	
Termination:	Tin	
Marking:	No	
AEC-Q200:	No	
Component Weight:	11 mg	
Shelf Life:	78 Weeks	
MSL:	1	

Specifications		
Capacitance:	0.022 uF	
Measurement Condition:	1 kHz 1.0Vrms	
Capacitance Tolerance:	10%	
Voltage DC:	100 VDC	
ESD Level per AEC-Q200:	25,000 V ESD Level	
Dielectric Withstanding Voltage:	250 VDC	
Temperature Range:	-55/+125°C	
Temperature Coefficient:	X7R	
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC):	15%, 1kHz 1.0Vrms	
Dissipation Factor:	2.5% 1 kHz 1.0Vrms	
Aging Rate:	3% Loss/Decade Hour: Referee Time is 1000 Hours	
Insulation Resistance:	45.4545 GOhms	

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